



High Compressive Strength Underfloor Heating Floorboard



Product Information

XFLO® boards are made from high compressive strength extruded polystyrene able to withstand the rigours of the installation process as well as the long term loads imposed in residential and commercial applications. The boards are manufactured to suit the pipe diameter and spacing required to achieve the desired thermal output.

Product Benefits

- High resistance to compression 250, 300 & 500kPa
- Manufactured to suit pipe and output requirements
- Works in conjunction with acoustic treatments

Technical Data		%FLO®		
		250	300	500
Product description	-	High compressive strength underfloor heating board		Ultra strength UFH board
Strength at 10% compression	kPa	250	300	500
Thermal conductivity	W/mK	0.033	0.033	0.035
Temperature range	°C	-50/+75	-50/+75	-50/+75
Route sizes available (to suit pipe diameter)	mm	10, 12, 14, 15, 16, 18, 20	10, 12, 14, 15, 16, 18, 20	10, 12, 14, 15, 16, 18, 20
Pipe centres	mm	150, 200, 300	150, 200, 300	150, 200, 300
Board size	mm	600 x 2500	600 x 2500	600 x 1250
Thickness' (other sizes manufactured to order)	mm	20, 25, 30, 35	40, 50, 60, 75	50, 60, 75

Third Party Accreditation and Approvals









Environmental Credentials













